

LCD Specification

LCD Group

LS028B7UX01 LCD Module

Product Specification

June 2007

Transflective 240 × 400 portrait-mode LCD Module featuring high integration and wide viewing angles. Full Specifications Listing.

PREPARED BY : DATE
K.Himeshima: Jun 27,2007

SHARP

SPEC No.: LCP-2707023

FILE No.:

ISSUE: Jun 27,2007

PAGE: 19 pages

CHECKED BY : DATE
T.Omori : Jun 27,2007

MOBILE LIQUID CRYSTAL DISPLAY DIVISION II
SHARP CORPORATION

CHECKED BY : DATE
T.Yamaue : Jun 27,2007

S P E C I F I C A T I O N

APPLICABLE GROUP
Mobile LCD Group II

DEVICE SPECIFICATION FOR

CG-Silicon TFT-LCD module

MODEL No. **LS028B7UX01**

CUSTOMER'S APPROVAL

DATA _____

BY _____

PRESENTED

BY



K. Himeshima

DEPARTMENT GENERAL MANAGER
ENGINEERING DEPARTMENT I
MOBILE LCD DIVISION II
MOBILE LCD GROUP
SHARP CORPORATION

RECORDS OF REVISION

MODEL No.: LS028B7UX01

SPEC No.: LCP-2707023

[illegible]

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(1) Application

This literature applies to LS028B7UX01.

(2) Overview

This module is a color transfective and active matrix LCD module incorporating CG silicon TFT (Thin Film Transistor), named mASV-TFT(mobile-ASV TFT). It is composed of a color TFT-LCD panel, a driver IC, a FPC, a back light and a back sealed casing.

Graphics and texts can be displayed on a $240 \times 3 \times 400$ dots panel with 262,144 colors by supplying.

(3) General specifications

Table 1

Parameter	Specifications	Remarks
Screen size (Diagonal)	2.75" Diagonal	inch
Pixel format	240(H) × 400(V) (1 pixel = R+G+B dots)	
Pixel pitch	0.050 (H) × 0.150 (V)	
Top Polarizer	3H Hardcoat	
Interface	8/16 bit CPU bus	
Display active area	36.00(H) × 60.00(V) mm	
Unit outline dimension	41.8(W) × 70.5(H) × 2.3 (D)	【Note3-1】
Mass	10 grams	(TYP.)

【Note 3-1】

Excluding protrusion. For detailed measurements and tolerances, please refer to Fig. 1.

(4) Absolute Maximum Ratings

Table 2

Ta=25°C

Parameter	Symbol	Condition	Ratings	Unit	Remark
Supply voltage for LCD	VDD	—	-0.5~+6.0	V	VDD ≥ VDDIO
Supply voltage for Logic	VDDIO	—	-0.5~+6.0	V	
Input voltage (Digital)	VIN	—	-0.5~VDDIO+0.5	V	【Note4-1】
LED Power dissipation	P _{D LED}	—	123	mW	【Note4-2】
LED current	IL	—	30	mA	
Operating temperature (panel surface)	T _{op}	—	-10~60	°C	【Note4-3】
Storage temperature	T _{stg}	—	-30~70	°C	

【Note4-1】 Applies to RESET,RS,CS,/WR,/RD,D0~D15

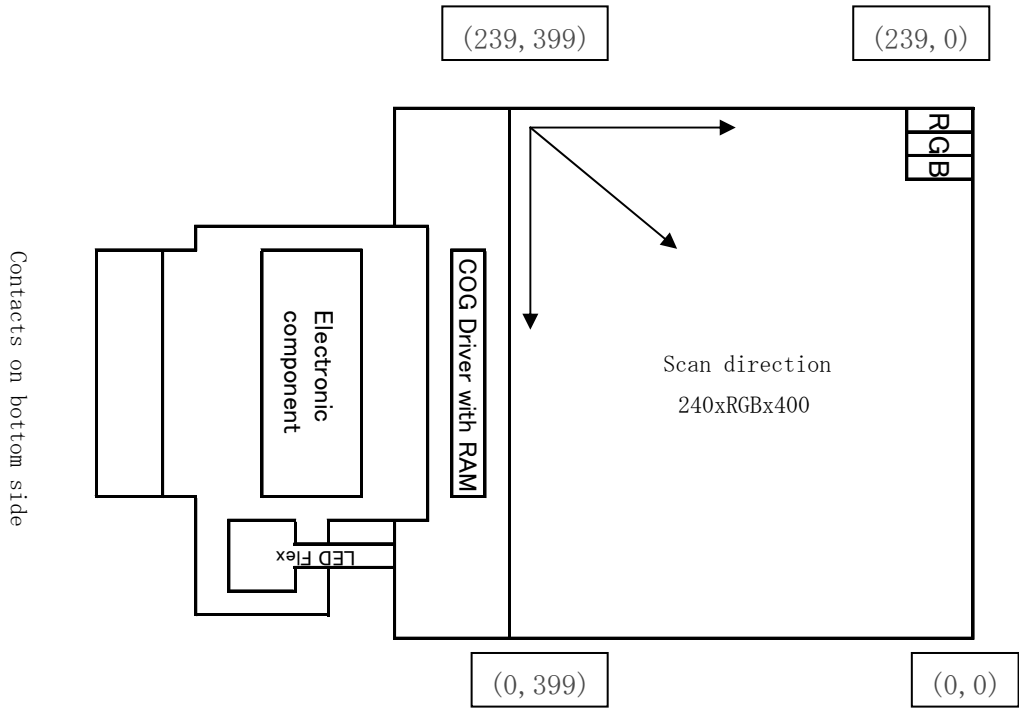
【Note4-2】 Specification for LED per 1pcs

【Note4-3】 Humidity: 95%RH Max.

(at Ta ≤ 40°C).Maximum wet-bulb temperature is less than 39°C

(at Ta > 40°C). Condensation of dew must be avoided.

(5)Pixel and polarization configuration



(6)Input/Output terminal

6-1)TFT-LCD panel driving section

Table3

Pin No.	Symbol	I/O	Description	Remarks
1	VDDIO	-	Logic I/O power supply	-
2	VPP	-	Open or VDDIO	-
3	VDD	-	LCD power supply	-
4	BWS0	I	BWS0=L :16bit, BWS0=H :8bit	-
5	RESET	I	Reset signal input	“L” active
6	VSYNCO	O	Indicates start of frame	
7	VSS	-	GND	
8	CS	I	Chip select input	“L” active
9	RS	I	Register select input	-
10	/RD	I	Read control input	“L” active
11	/WR	I	Write control input	“L” active
12	VSS	-	GND	-
13	D0	I/O	Data bus(LSB)	-
14	D1	I/O	Data bus	-
15	D2	I/O	Data bus	-
16	D3	I/O	Data bus	-
17	D4	I/O	Data bus	-
18	D5	I/O	Data bus	-
19	D6	I/O	Data bus	-
20	D7	I/O	Data bus	-
21	VSS	-	GND	-
22	D8	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
23	D9	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
24	D10	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
25	D11	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
26	D12	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
27	D13	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
28	D14	I/O	Data bus If 8bit-I/F is used, connect to GND level.	-
29	D15	I/O	Data bus(MSB) If 8bit-I/F is used, connect to GND level.	-
30	VSS	-	GND	-
31	LED_AN	-	LED Anode	-
32	LED_CA	-	LED Cathode	-

Used connction: 0.5mm pitch FPC connector

Correspondable connector: 32FLH-SM1-TB(JST)

(7)Color Input Reference & Data Transfer

Colors & Gray Scale	Gray scale Levels	Data Signal																	
		R 0	R 1	R 2	R 3	R 4	R 5	G 0	G 1	G 2	G 3	G 4	G 5	B 0	B 1	B 2	B 3	B 4	B 5
Black	--	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Blue	--	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
Green	--	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Cyan	--	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
Red	--	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Magenta	--	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
Yellow	--	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
White	--	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
↑ Darker ↓	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
↓ Brighter ↓																			
	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
↑ Darker ↓	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
↓ Brighter ↓																			
	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
↑ Darker ↓	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
↓ Brighter ↓																			
	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
Blue	GS63	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

SRAM Data and 8-bit+8-bit 2 times transfer

CPU bus data																	
1 st 8bit									2 nd 8-bit								
D7	D6	D5	D4	D3	-	D2	D1	D0	D7	D6	D5	D4	D3	D2	D1	D0	-
RAM data																	
D17	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
RDATA						GDATA						BDATA					
1 pixel																	

*Display RAM data D12 and D0 are complemented by CPU bus data DB7 of the first transfer and DB4 of the second transfer.

(8)Electrical characteristics

8-1)Recommended operating conditions

A) TFT-LCD panel driving section

Table 4

VSS=0V

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Applicable Pin
Supply voltage for LCD	VDD-VSS	Ta=-10~60 °C	2.8	3.3	3.35	V	VDD
Supply voltage for Logic	VDDIO-VSS		1.6	3.3	3.35	V	VDDIO 【Note8-1】
Input leakage current	I _{LI}	Ta=-10~60 °C V _{IN} = VSS or VDDIO	-	-	10	μ A	【Note8-2】
”H” level input voltage	V _{IH}	Ta=-10~60 °C	0.8V _{DDIO}	-	-	V	
”L” level input voltage	V _{IL}		-	-	0.2V _{DDIO}	V	
”H” level output voltage	V _{OH}	Ta=-10~60 °C I _{OH} =-1 00 μ A , I _{OL} = 1 00 μ A	0.8V _{DDIO}	-	-	V	【Note8-3】
”L” level output voltage	V _{OL}		-	-	0.2V _{DDIO}	V	

【Note8-1】 V_{DD} ≥ V_{DDIO}

【Note8-2】 Input mode of D0~D15pins, RESET, RS, /RD, /WR, CS

【Note8-3】 Output mode of D0~D15 pins,VSYNCO

B) Back light driving section

Table 5

Ta=25 °C

Parameter	Symbol	MIN	TYP	MAX	Units	Remarks terminal
LED voltage	V _{L1} -V _{L2}	—	16	17.5	V	
LED current	I _L	—	20	25	mA	
Power consumption	W _L	—	320	350	mW	【Note 8-4】

【Note 8-4】 Measurement Conditions

4V applied to 5 LED's in series.

Calculated reference value(I_L(TYP) × (V_{L1} - V_{L2}))

8-2)Power consumption

Table 6

Ta=25 °C

Parameter	Symbol	Conditions	MIN	TYP	MAX	Unit	Remarks
Power consumption, Panel	P _{LCD}	VDD=3.3V VDDIO=3.3V	-	33	46.2	mW	【Note 8-5】
Power consumption, Standby	P _{ST}	VSS=0V	-	-	200	μ W	【Note 8-6】

【Note 8-5】 Measurement Conditions

frame frequency= 60 Hz

262k-color mode

All white pattern

No Host CPU access

【Note 8-6】 Measurement Conditions

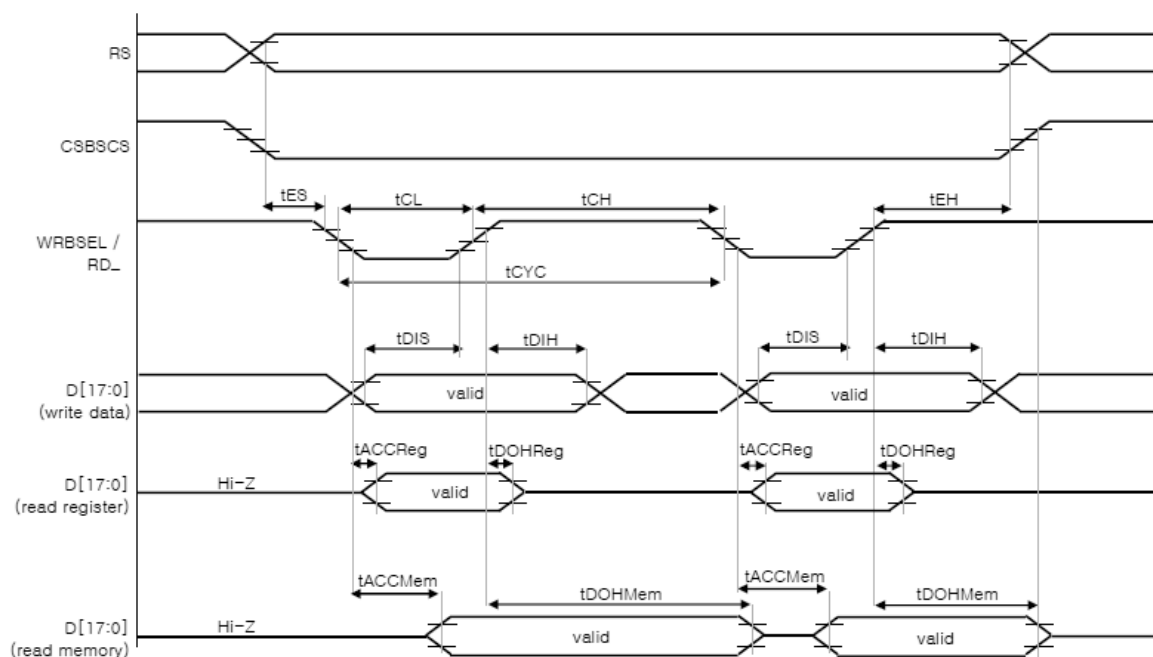
Standby mode (Oscillation OFF/ Display OFF)

No Host CPU access

VDD & VDDIO present; RESET,/RD,/WR,CS are high, VPP=N.C.

8-3) Timing diagrams of input signals(80-family MPU access)

a)Write/Read timing



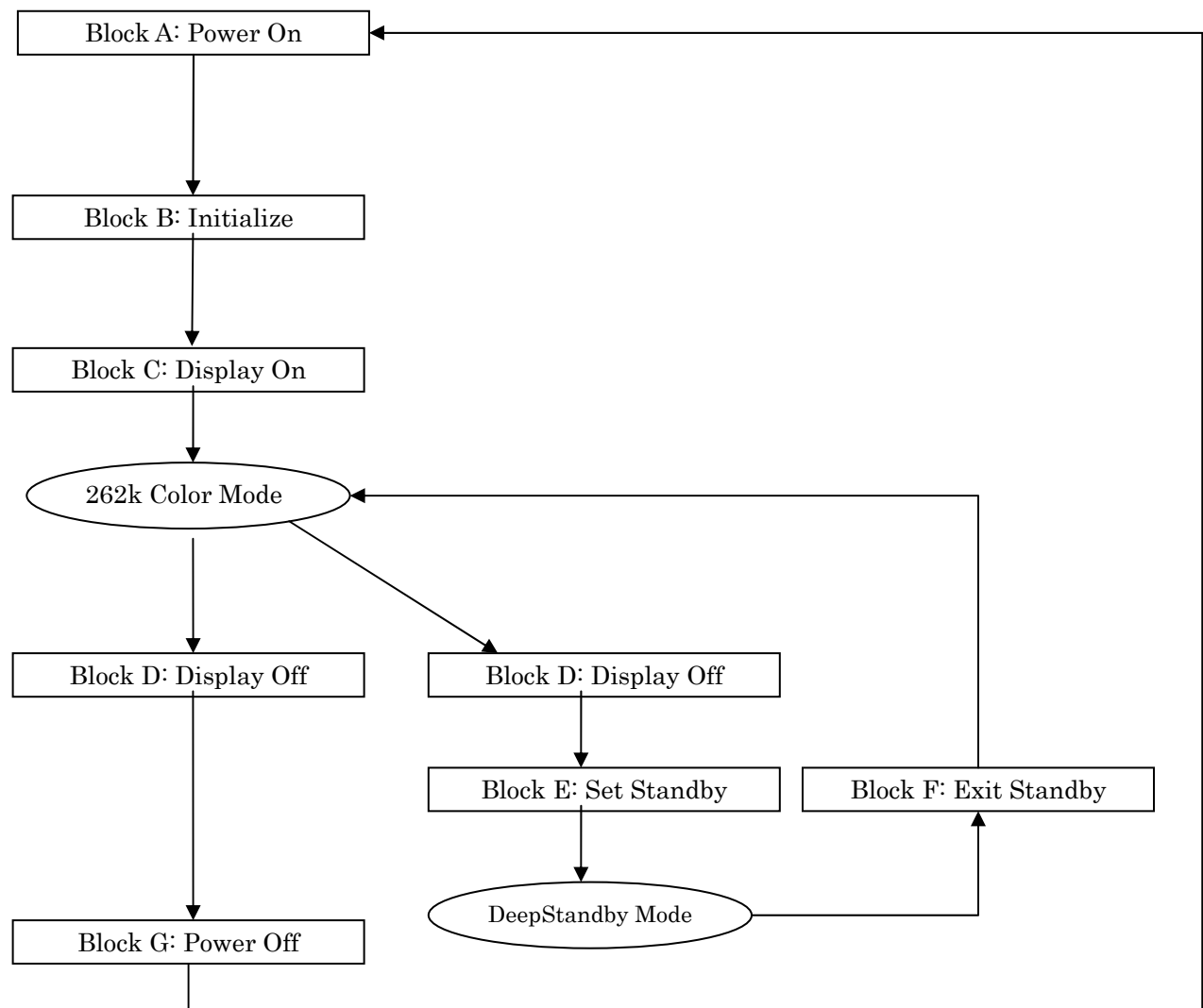
The read or write operation starts when both of the /CS and /WR(/RD) are low.

(TA=25°C, DGND=AGND=0V, VDDC=VDDIO=Recommended Operating Conditions)

Item	記号	condition	MIN	TYP	MAX	unit
enable Setup Time	tES	CSBSCS,RS	40			nS
enable Hold Time	tEH	CSBSCS,RS	40			nS
Clock Cycle Period	tCYC	Write Register	80			nS
		Write Memory	110			nS
		Read Register	VDDIO≥2.2V CL=10pF			nS
		Read Register	VDDIO≥2.2V CL=30pF			nS
		Read Memory	VDDIO≥2.2V CL=10pF			nS
Clock Low Width	tCL	Write Register/Memory	40			nS
		Read Register	VDDIO≥2.2V CL=10pF			nS
		Read Register	VDDIO≥2.2V CL=30pF			nS
		Read Memory	VDDIO≥2.2V CL=10pF			nS
		Read Memory	VDDIO≥2.2V CL=30pF			nS
Clock High Width	tCH	Write/Read Register	40			nS
		Write/Read Memory	70			nS
Write Data Setup Time	tDIS	D0-D17	40			nS
Write Data Hold Time	tDIH	D0-D17	30			nS
Register Access Delay	tACCRReg	D0-D17	VDDIO≥2.2V CL=10pF		75	nS
					100	nS
		D0-D17	VDDIO≥2.2V CL=30pF		130	nS
					190	nS
Memory Access Delay	tACCMem	D0-D17	VDDIO≥2.2V CL=10pF		135	nS
					150	nS
		D0-D17	VDDIO≥2.2V CL=30pF		165	nS
					210	nS
Read Data(Register) Hold Time	tDOHReg	D0-D17	10		50	nS
Read Data(Memory) Hold Time	tDOHMem	D0-D17	10		50	nS
Rising/Falling Time	tr,tf	All signals			15	nS

(9)Software Flow & Register Settings

9-1) Software Flow



9-2) Register Settings

Block A: Power On

Step	Register	Setting	Operation
1			RESETB=L
2			VDDIO ON
3			VDD ON
4			Wait 10ms
5			Logic initial state (CSB, WRB, RDB=H)
6			Reset release. (RES = "L" →"H")
7			Wait 0.5ms

Block B: Initialize

Step	Register	Data	Operation
1	01	02	8bit 8/8 transfer
2	68	07	
3	69	40	
4	08	00	Normally black
5	10	F0	Panel X-size=240
6	11	90	Panel Y-size=400
7	12	01	
8	1E	50	Number of vertical line=400
9	1D	07	RAM write direction:landscape
10	1A	EF	RAM pointer X
11	1B	8F	RAM pointer Y
12	1C	01	
13	30	81	Select the display-RAM data
14	33	02	Non-display data color
15	42	07	Vertical front poach=7h
16	43	01	Vertical back poach=1h
17	44	0F	H scan interval=47clock
18	45	08	GSP start position=4clock
19	46	06	GCK start position=6clock
20	48	01	VCOM inversion position=1clock
21	4A	01	Signal setting
22	4B	A8	SSD setting
23	4C	07	ASW start position=7clock
24	5A	00	Battery pull-out detection off
25	62	29	ASW width5, interval 1clock
26	65	02	AMP bias current setting
27	66	05	VGM5.1V
28	6A	02	VCOM output
29	81	44	VR, VS boost clock setting
30	82	15	DCK, DCKB timing setting
31	83	27	DCDC dual, VS5.4V, DCDC drivability=min
32	84	12	VR setting
33	85	26	DCDC dual, VR5.3V, DCDC drivability=min
34	86	17	VS setting
35	90	25	Auto on timing setting
36	91	05	Auto ON/OFF setting(1V)
37	92	15	Auto OFF timing setting
38	31	01	VAL

Block C: Display On

Step	Register	Setting	Operation
1	03		RAM write
2	3E	01	Auto ON sequence
3	Wait 120ms		

Block D: Display Off

Step	Register	Setting	Operation
1	30	80	All black display
2	Wait 50ms		
3	C0	00	
4	3E	02	Auto OFF sequence
5	Wait 100ms		

Block E: Set Standby

Step	Register	Setting	Operation
1	07	00	Sscillator OFF
2	80	01	Deep standby

Block F: Exit Standby

Step	Register	Setting	Operation
1	80	81	Deep standby out
2	Wait 0.1ms		
3	07	01	Oscillator on
4	Wait 1ms		
5	C0	02	
6	Wait 1ms		
7	3E	01	Auto ON sequence
8	Wait 120ms		
9	30	81	Display ON

Block G: Power Off

Step	Register	Setting	Operation
1	RESETB=L		
2	VDD OFF (Analog voltage Off)		
3	VDDIO OFF (IO voltage OFF)		

(10)Optical characteristics

10-1)Not driving the Back light condition

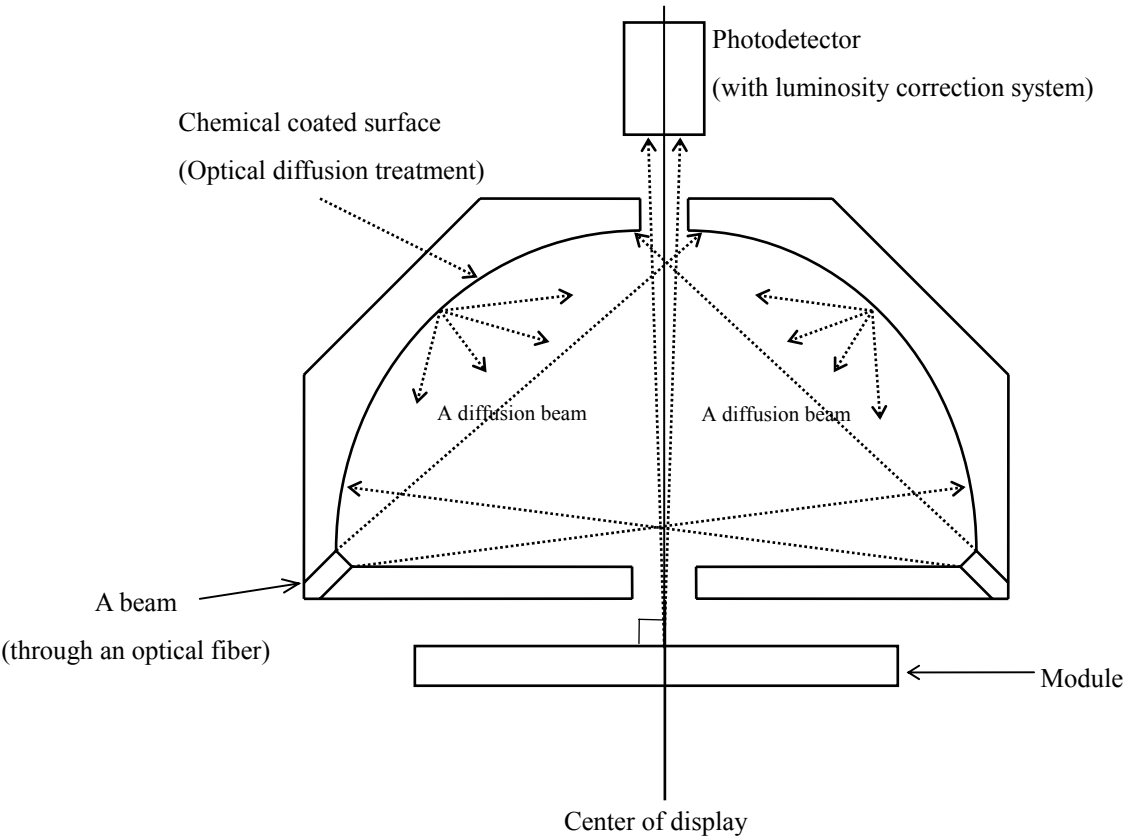
Table 7 VDD=3.3V、VDDIO=1.8V

Ta=25°C

Parameter		Symbol	Condition	Min	Typ	Max	Unit	Remarks
Viewing angle range		θ21,22	CR≥2	40	50	-	degree	[Note 10-1,2]
		θ11		40	50	-	degree	
		θ12		40	50	-	degree	
Contrast ratio		CR	θ=0°	9	13	-	-	[Note 10-2,3]
Response time	Rise	τ r	θ=0°	-	20	30	ms	[Note 10-4]
	Fall	τ d		-	10	15	ms	
White chromaticity		x	θ=0°	-	0.31	-	-	
		y		-	0.34	-	-	
Reflection ratio		R	θ=0°	1.6	2.5	-	%	[Note 10-5]

* The measuring method of the optical characteristics is shown by the following figure.

* A measurement device is Otsuka luminance meter LCD5200.(With the diffusion reflection unit.)



Measuring method (a) for optical characteristics

10-2)Driving the Back light condition

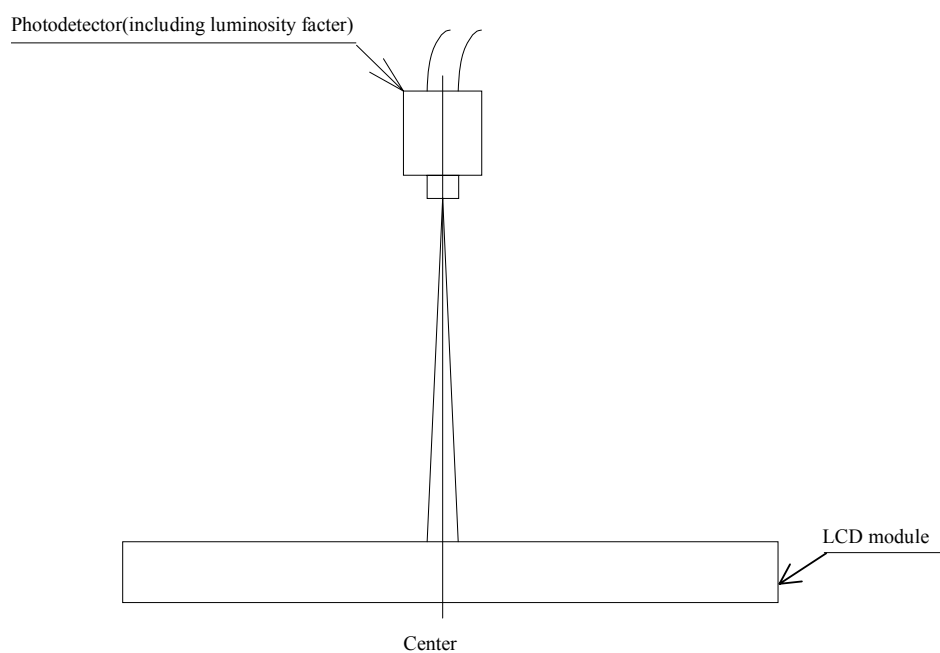
Table 8 VDD=3.0V、VDDIO=1.8V

Ta=25°C

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Remarks
Viewing angle range	θ11	CR≥5	55	80	-	degree	[Note 10-1,2]
	θ12		55	80	-	degree	
	θ21		55	80	-	degree	
	θ22		55	80	-	degree	
Contrast ratio	CR	$\theta = 0^\circ$	280	400	-	-	[Note 10-2]
Response time	Rise	$\theta = 0^\circ$	-	25	35	ms	[Note 10-4]
	Fall		-	15	20	ms	
White chromaticity	x	$\theta = 0^\circ$	0.25	0.30	0.35	-	
	y		0.27	0.32	0.37	-	
Brightness	Y	$\theta = 0^\circ$	210	300	-	cd/m ²	IL=20mA
NTSC ratio			-	70	-	%	

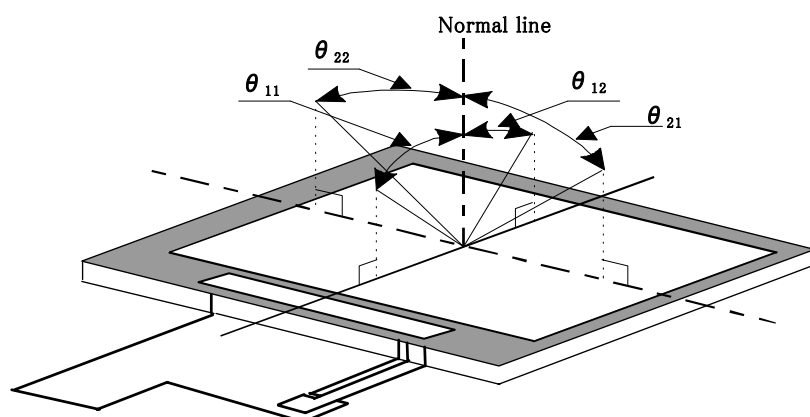
* The measuring method of the optical characteristics is shown by the following figure.

* A measurement device is TOPCON luminance meter SR-3.(Viewing cone 1)



Measuring method (c) for optical characteristics

[Note 10-1] Viewing angle range is defined as follows.



Definition for viewing angle

[Note10-2] Definition of contrast ratio:

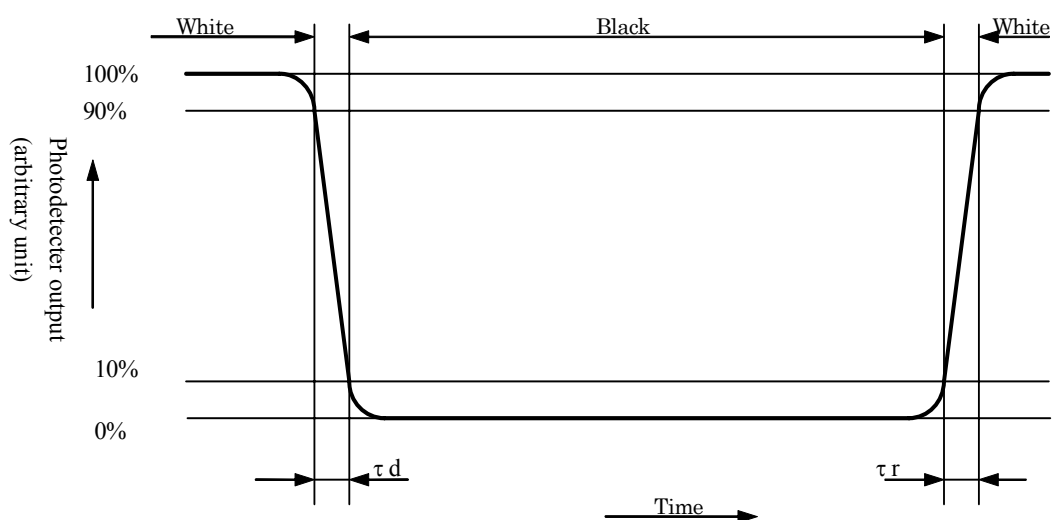
The contrast ratio is defined as follows:

$$\text{Contrast ratio (CR)} = \frac{\text{Photodetector output with all pixels white (GS63)}}{\text{Photodetector output with all pixels black (GS0)}}$$

[Note10-3] A measurement device is Minolta CM-2002.

[Note10-4] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



[Note10-5] Definition of reflection ratio

$$\text{Reflection ratio} = \frac{\text{Light detected level of the reflection by the LCD module}}{\text{Light detected level of the reflection by the standard white board}}$$

(11) Display quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standards for TFT-LCD.

(12) Mechanical characteristics

12-1) External appearance

See Fig. 1

12-2) FPC (for LCD panel) characteristics

(1) Specific connector

32FLH-SM1-TB(JST)

(13) Handling Precautions

13-1) Insertion and taking out of FPCs

Be sure insert and take out of the FPC into the connector of the set after turning off the power supply on the set side.

13-2) Handling of FPCs

The FPC for LCD panel shall be bent only slit portion. The bending slit shall be bent uniformly on the whole slit portion with bending radius larger than 0.6mm ,and only inner side (back side of the module). Don't bend it outer side (display surface side).

Don't give the FPCs too large force, for example, hanging the module with holding FPC.

13-3) Installation of the module

On mounting the module, be sure to fix the module on the same plane. Taking care not to warp or twist the module.

13-4) Precaution when mounting

(1) If water droplets and oil attaches to it for a long time, discoloration and staining occurs.

Wipe them off immediately.

(2) Glass is used for the TFT-LCD panel. If it is dropped or bumped against a hard object, it may be broken. Handle it with sufficient care.

(3) As the CMOS IC is used in this module, pay attention to static electricity when handling it.

Take a measure for grounding on the human body.

13-5) Others

(1) The liquid-crystal is deteriorated by ultraviolet rays. Do not leave it in direct sunlight and strong ultraviolet rays for many hours.

(2) If it is kept at a temperature below the rated storage temperature, it becomes coagulated and the panel may be broken. Also, if it is kept at a temperature above the rated storage temperature, it becomes isotropic liquid and does not return to its original state. Therefore, it is desirable to keep it at room temperature as much as possible.

(3) If the LCD breaks, don't put internal liquid crystal into the mouth. When the liquid crystal sticks to the hands, feet and clothes, wash it out immediately.

(4) Wipe off water drop or finger grease immediately. Long contact with water may cause discoloration or spots.

(5) Observe general precautions for all electronic components.

(14) Reliability Test Conditions for TFT-LCD Module

Table 9

No.	Test items	Test conditions	
1	Low temperature storage test	Ta=-30℃	240h
2	High temperature storage test	Ta=+70℃	240h
3	Thermal Shock storage test	Ta=-30℃:1h~70℃:1h	50cycles
4	Low temperature operating test	Ta=-10℃	240h
5	High temperature operating test	Ta=+60℃	240h
6	High temperature and high humidity operating test	Ta=+40℃ , 95%RH (But no condensation of dew)	240h
7	Electro static discharge test	$\pm 2\text{kV} \cdot 100\text{pF}(1.5\text{k}\Omega)$ 1 time for each terminals	
8	Shock test	980 m/s ² , 6 ms $\pm X, \pm Y, \pm Z$ 3 times for each direction (JIS C0041, A-7 Condition C)	
9	Vibration test	Frequency range: 10Hz~55Hz Stroke: 1.5 mm Sweep: 10Hz~55Hz X,Y,Z 2 hours for each direction (total 6 hours) (JIS C0040,A-10 Condition A)	

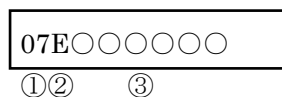
【Note】 Ta = Ambient temperature

【Check items】 Test No.1~9 : In the standard condition, there shall be no practical problems that may affect the display function.

(15) Others

15-1) Indication of lot number

The lot number is printed in the position shown in Fig. 1. (Outline Dimensions).



①product year 2007:7, 2008:8

②product month Jan:A, Feb:B, Mar:C, ······Oct:J, Nov:K, Dec:L

③serial number

15-2) Used Regulation of Chemical Substances Breaking Ozone Stratum

Substances with the object of regulating : CFCS, Carbon tetrachloride, Halon

1,1,1-Trichloro ethane (Methyl chloroform)

- (a) This LCD module, Constructed part and Parts don't contain the above substances.
- (b) This LCD module, Constructed part and Parts don't contain the above substances in processes of manufacture.

15-3) If some problems arise about mentioned items in this document and other items, the user of the TFT-LCD module and Sharp will cooperate and make efforts to solve the problems with mutual respect and good will.

(16) Forwarding form

- a) Piling number of cartons : 8 deep
- b) Package quantity in one cartons : 400(pcs)
- c) Carton size : (w) 382×(D) 578×(H) 255 (mm)
- d) Total mass of 1 carton filled with full modules : approximately 9.5 (Kg)

Conditions for storage

Environment

- (1)Temperature : 0~40°C
- (2)Humidity : 60%RH or less (at 40°C)
No dew condensation at low temperature and high humidity.
- (3)Atmosphere : Harmful gas, such as acid or alkali which bites electronic components and/or wires, must not be detected.
- (4)Period : about 3 months
- (5)Opening of the package : In order to prevent the LCD module from breakdown by electrostatic charges, please control the room humidity over 50%RH and open the package taking sufficient countermeasures against electrostatic charges, such as earth, etc.

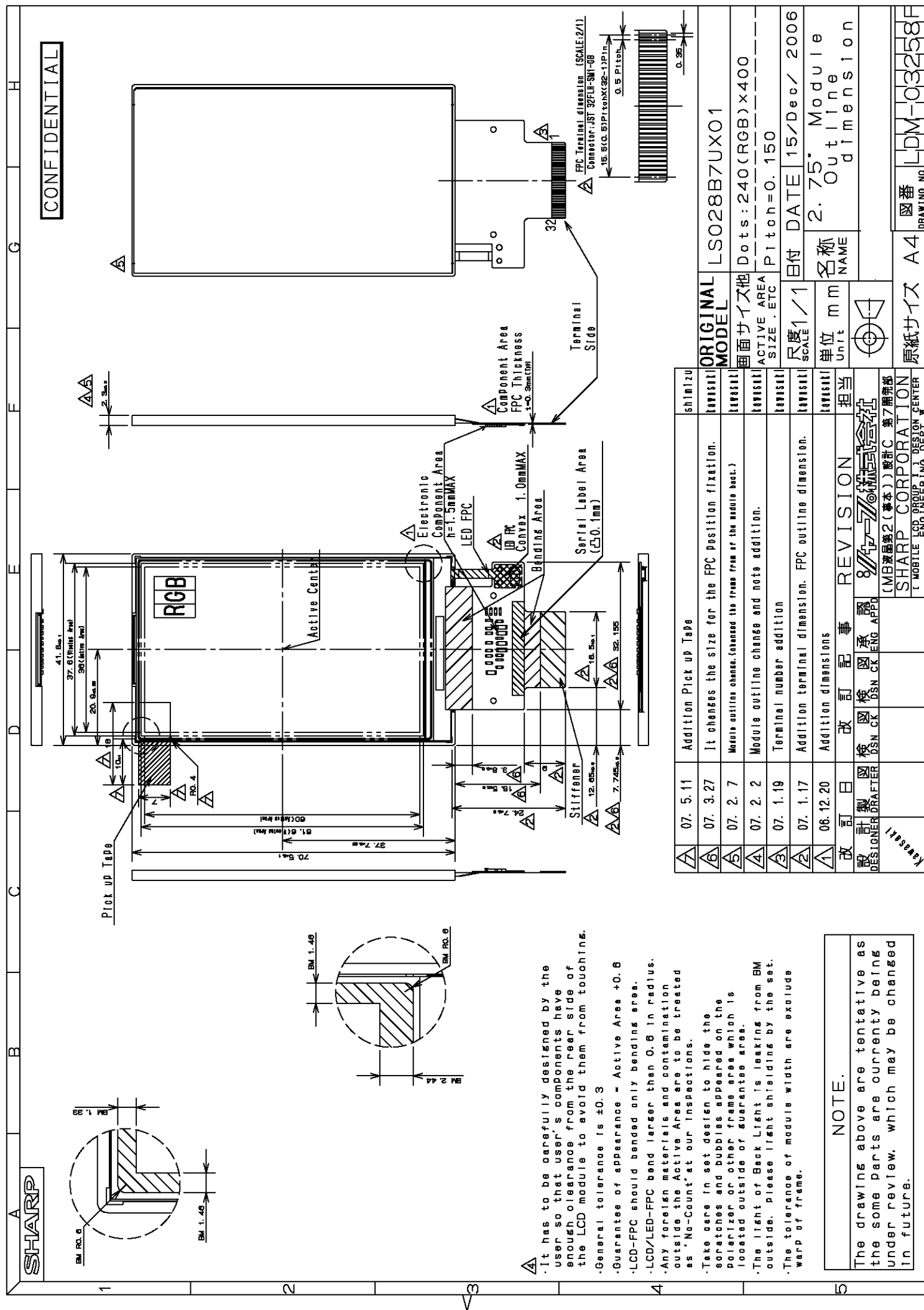


Fig.1 Outline Dimensions

LCD Specification

LCD Group



NORTH AMERICA

Sharp Microelectronics of the Americas
5700 NW Pacific Rim Blvd.
Camas, WA 98607, U.S.A.
Phone: (1) 360-834-2500
Fax: (1) 360-834-8903
www.sharpsma.com

TAIWAN

Sharp Electronic Components
(Taiwan) Corporation
8F-A, No. 16, Sec. 4, Nanking E. Rd.
Taipei, Taiwan, Republic of China
Phone: (886) 2-2577-7341
Fax: (886) 2-2577-7326/2-2577-7328

CHINA

Sharp Microelectronics of China
(Shanghai) Co., Ltd.
28 Xin Jin Qiao Road King Tower 16F
Pudong Shanghai, 201206 P.R. China
Phone: (86) 21-5854-7710/21-5834-6056
Fax: (86) 21-5854-4340/21-5834-6057
Head Office:
No. 360, Bashen Road,
Xin Development Bldg. 22
Waigaoqiao Free Trade Zone Shanghai
200131 P.R. China
Email: smc@china.global.sharp.co.jp

EUROPE

Sharp Microelectronics Europe
Division of Sharp Electronics (Europe) GmbH
Sonninstrasse 3
20097 Hamburg, Germany
Phone: (49) 40-2376-2286
Fax: (49) 40-2376-2232
www.sharpsme.com

SINGAPORE

Sharp Electronics (Singapore) PTE., Ltd.
438A, Alexandra Road, #05-01/02
Alexandra Technopark,
Singapore 119967
Phone: (65) 271-3566
Fax: (65) 271-3855

KOREA

Sharp Electronic Components
(Korea) Corporation
RM 501 Geosung B/D, 541
Dohwa-dong, Mapo-ku
Seoul 121-701, Korea
Phone: (82) 2-711-5813 ~ 8
Fax: (82) 2-711-5819

JAPAN

Sharp Corporation
Electronic Components & Devices
22-22 Nagaïke-cho, Abeno-Ku
Osaka 545-8522, Japan
Phone: (81) 6-6621-1221
Fax: (81) 6117-725300/6117-725301
www.sharp-world.com

HONG KONG

Sharp-Roxy (Hong Kong) Ltd.
3rd Business Division,
17/F, Admiralty Centre, Tower 1
18 Harcourt Road, Hong Kong
Phone: (852) 28229311
Fax: (852) 28660779
www.sharp.com.hk
Shenzhen Representative Office:
Room 13B1, Tower C,
Electronics Science & Technology Building
Shen Nan Zhong Road
Shenzhen, P.R. China
Phone: (86) 755-3273731
Fax: (86) 755-3273735

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